# VS-HFA06TB120SPbF

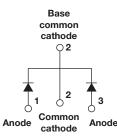
Vishay Semiconductors

HALOGEN

### HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 2 x 4 A



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PRODUCT SUMMARY								
Package	TO-263AB (D <sup>2</sup> PAK)							
I <sub>F(AV)</sub>	8 A							
V <sub>R</sub>	600 V							
V <sub>F</sub> at I <sub>F</sub>	2.2 V							
t <sub>rr</sub> (typ.)	17 ns							
T <sub>J</sub> max.	150 °C							
Diode variation	Common cathode							

#### FEATURES

- Ultrafast and ultrasoft recovery
- Very low I<sub>RRM</sub> and Q<sub>rr</sub>
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
   RoHS
   COMPLIANT
- AEC-Q101 qualified
- Material categorization: For definitions of FREE compliance please see <u>www.vishay.com/doc?99912</u>

#### BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

#### DESCRIPTION

VS-HFA08TA60CSPbF is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 4 A per leg continuous current, the VS-HFA08TA60CSPbF is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED<sup>®</sup> product line features extremely low values of peak recovery current (I<sub>RBM</sub>) and does not exhibit any tendency to "snap-off" during the t<sub>b</sub> portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA08TA60CSPbF is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Cathode to anode voltage	V <sub>R</sub>		600	V						
Maximum continuous forward current		T <sub>C</sub> = 100 °C	4							
per devi	ice I <sub>F</sub>	IC = 100 C	8	А						
Single pulse forward current	I <sub>FSM</sub>		25	~						
Maximum repetitive forward current	I <sub>FRM</sub>		16							
Maximum power dissipation	р	T <sub>C</sub> = 25 °C	25	w						
Maximum power dissipation	PD	T <sub>C</sub> = 100 °C	10	vv						
Operating junction and storage temperature rang	e T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C						

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1

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<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J$ = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Cathode to anode breakdown voltage	V <sub>BR</sub>	<sub>R</sub> I <sub>R</sub> = 100 μA			-	-				
	V <sub>FM</sub>	I <sub>F</sub> = 4.0 A		-	1.5	1.8	V			
Maximum forward voltage		I <sub>F</sub> = 8.0 A	See fig. 1	-	1.8	2.2				
		$I_F = 4.0 \text{ A}, T_J = 125 \text{ °C}$		-	1.4	1.7				
Maximum reverse		$V_R = V_R$ rated	See fig. 0	-	0.17	3.0				
leakage current	I <sub>RM</sub>	$T_J = 125 \text{ °C}, V_R = 0.8 \text{ x } V_R \text{ rated}$	See fig. 2	-	44	300	μΑ			
Junction capacitance	CT	V <sub>R</sub> = 200 V See fig. 3		-	4.0	8.0	pF			
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from p	ackage body	-	8.0	-	nH			

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, \ dI_F/dt = 200 \text{ A}$	A/μs, V <sub>R</sub> = 30 V	-	17	-				
Reverse recovery time See fig. 5, 6 and 16	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	28	42	ns			
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C	I <sub>F</sub> = 4.0 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	38	57				
Peak recovery current See fig. 7 and 8	I <sub>RRM1</sub>	T <sub>J</sub> = 25 °C		-	2.9	5.2	A			
	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C		-	3.7	6.7				
Reverse recovery charge	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	40	60				
See fig. 9 and 10	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	70	105	no			
Peak rate of fall of recovery	dl <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C	]	-	280	-	A/µs			
current during t <sub>b</sub> See fig. 11 and 12	dl <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	235	-				

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C			
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	5.0	K/W			
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	80	rv vv			
Weight			-	2.0	-	g			
weight			-	0.07	-	oz.			
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)			
Marking device		Case style D <sup>2</sup> PAK		HFA08	TA60CS				

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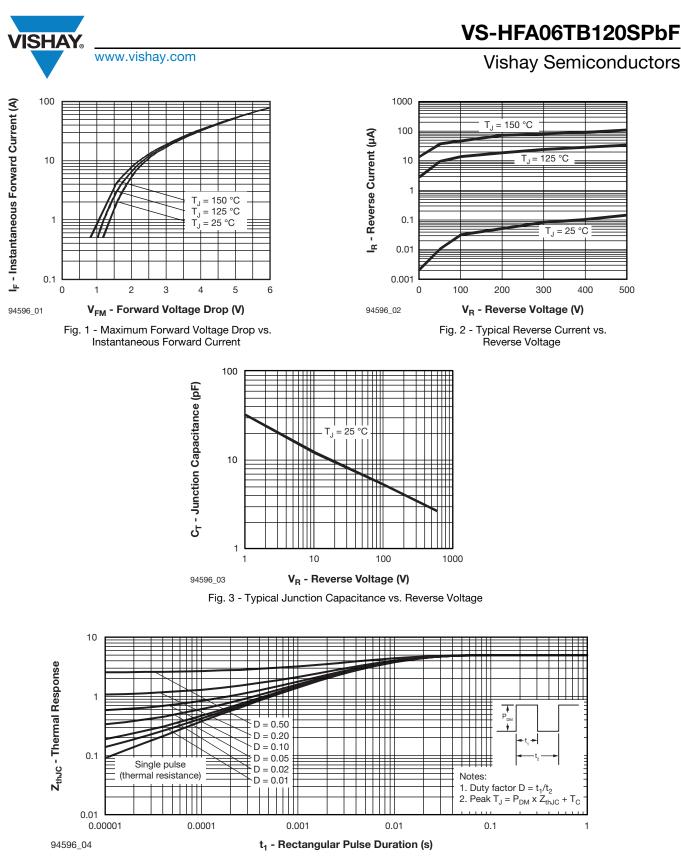


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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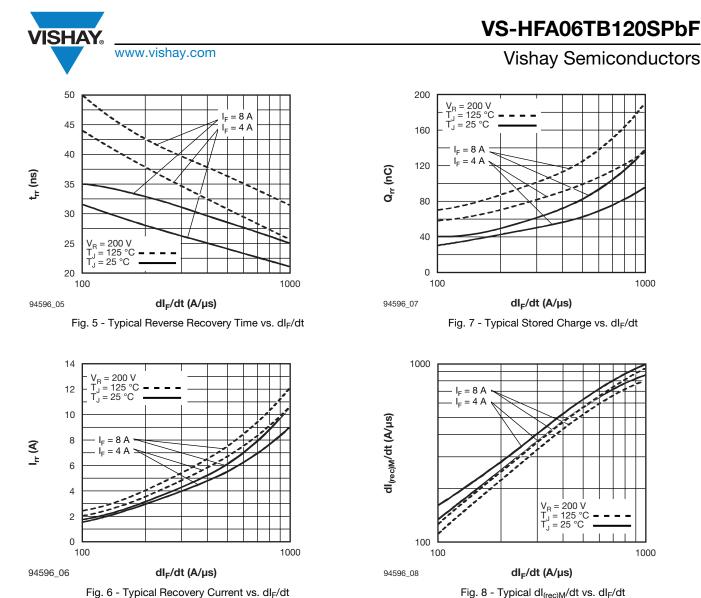


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt

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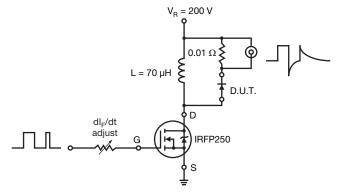
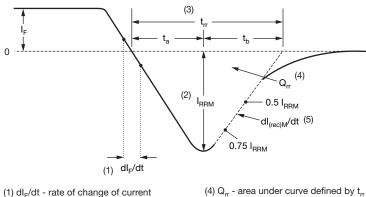
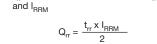


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.



- (5) dI\_{(rec)M}/dt peak rate of change of current during  $t_{\rm b}$  portion of  $t_{\rm rr}$
- Fig. 10 Reverse Recovery Waveform and Definitions

### **ORDERING INFORMATION TABLE**

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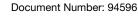
Device code	VS-	HF	Α	08	ТА	60	С	S	TRL	PbF		
		2	3	4	5	6	7	8	9	10		
	<ol> <li>Vishay Semiconductors product</li> <li>HEXFRED<sup>®</sup> family</li> </ol>											
		<ul> <li>Process designator: A = Electron irradiated</li> </ul>										
	<b>4</b> ·	- Cur	Current rating (08 = 8 A)									
	5	- Pac	kage ou	utline (T	A = TO-	220, 3 I	eads)					
	6	- Volt	tage rati	ng (60 =	= 600 V)	)						
	7	- Circ	cuit conf	iguratior	n (C = C	commor	n cathod	le)				
	8	• S =	D <sup>2</sup> PAK									
	9	• N	• None = Tube									
		<ul> <li>TRL = Tape and reel (left oriented)</li> </ul>										
		• TRR = Tape and reel (right oriented)										
	10 ·	- • PbF = Lead (Pb)-free										
		• P	= Lead	(Pb)-fre	e (for D	<sup>2</sup> PAK T	RR and	TRL)				

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-HFA08TA60CSPBF	50	1000	Antistatic plastic tube						
VS-HFA08TA60CSTRRP	800	800	13" diameter reel						
VS-HFA08TA60CSTRLP	800	800	13" diameter reel						

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### **Outline Dimensions**

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MIN.

0.270

0.380

0.311

0.575

0.070

0.050

0.188

0.100 BSC

0.010 BSC

MAX.

0.315

0.420

0.346

0.625

0.110

0.070

0.208

3

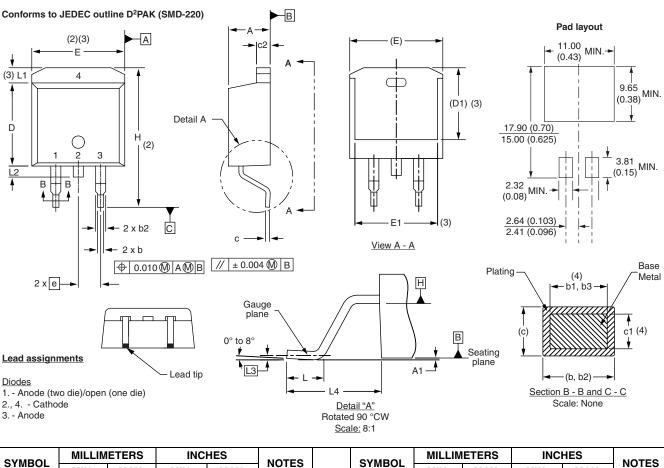
2, 3

З

3

D<sup>2</sup>PAK





SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		
STWDUL	MIN.	MAX.	MIN.	MAX.	NOTES	STWDUL	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	8.00	
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	
b1	0.51	0.89	0.020	0.035	4	е	2.54	BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	
С	0.38	0.74	0.015	0.029		L1	-	1.65	
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	

#### Notes

 $^{(1)}\,$  Dimensioning and tolerancing per ASME Y14.5 M-1994  $\,$ 

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

 $^{(3)}\,$  Thermal pad contour optional within dimension E, L1, D1 and E1

<sup>(4)</sup> Dimension b1 and c1 apply to base metal only

<sup>(5)</sup> Datum A and B to be determined at datum plane H

<sup>(6)</sup> Controlling dimension: inch

<sup>(7)</sup> Outline conforms to JEDEC outline TO-263AB

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 DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesAsia@vishay.com, DiodesAsia@vishay.com
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